

**TYPES A5T4026 THRU A5T4029, A8T4026 THRU A8T4029
P-N-P SILICON TRANSISTORS**

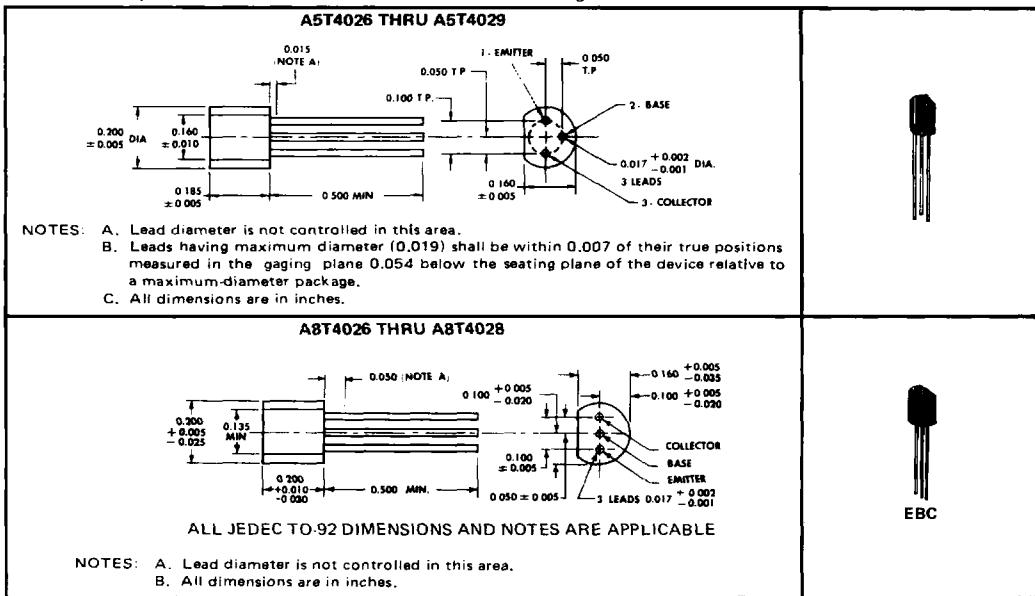
BULLETIN NO. DL-S 7312002, MARCH 1973

SILECT[†] TRANSISTORS[‡] FOR GENERAL PURPOSE APPLICATIONS

- High V(BR)CEO . . . 80 V Min (A5T4027, A5T4029, A8T4027, A8T4029)
 - High Current Capability . . . 1 A
 - Rugged One-Piece Construction with In-Line Leads or Standard TO-18 100-mil Pin-Circule Configuration

mechanical data

These transistors are encapsulated in a plastic compound specifically designed for this purpose, using a highly mechanized process developed by Texas Instruments. This case will withstand soldering temperatures without deformation. These devices exhibit stable characteristics under high-humidity conditions and are capable of meeting MIL-STD-202C, Method 106B. The transistors are insensitive to light.



absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)

Collector-Base Voltage	A5T4026	A5T4027
Collector-Emitter Voltage (See Note 1)	A5T4028	A5T4029
Emitter-Base Voltage	A8T4026	A8T4027
Continuous Collector Current	A8T4028	A8T4029
Continuous Device Dissipation at (or below) 25°C Free-Air Temperature (See Note 2)	-60 V	-80 V
Continuous Device Dissipation at (or below) 25°C Lead Temperature (See Note 3)	-60 V	-80 V
Storage Temperature Range	-5 V	-5 V
Lead Temperature 1/16 Inch from Case for 10 Seconds	1 A	625 mW
	1.25 W	65°C to 150°C
	260°C	

NOTES: 1. These values apply between 0 and 10 mA collector current when the base-emitter diode is open-circuited.
2. Derate linearly to 150°C free-air temperature at the rate of 5 mW/°C.
3. Derate linearly to 150°C lead temperature at the rate of 10 mW/°C. Lead temperature is measured on the collector lead 1/16 inch from the case.

[†]Trademark of Texas Instruments
[‡]U.S. Patent No. 3,439,238

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electrical characteristics at 25°C free-air temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	A5T4026		A5T4027		A5T4028		A5T4029		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
$V_{(BR)CBO}$ Collector-Base Breakdown Voltage	$I_C = -10 \mu A, I_E = 0$	-60		-80		-60		-80		V
$V_{(BR)CEO}$ Collector-Emitter Breakdown Voltage	$I_C = -10 mA, I_B = 0,$ See Note 4	-60		-80		-60		-80		V
$V_{(BR)EBO}$ Emitter-Base Breakdown Voltage	$I_E = -10 \mu A, I_C = 0$	-5		-5		-5		-5		V
I_{CBO} Collector Cutoff Current	$V_{CB} = -50 V, I_E = 0$		-50			-50				nA
	$V_{CB} = -60 V, I_E = 0$			-50				-50		
	$V_{CB} = -50 V, I_E = 0,$ $T_A = 100^\circ C$		-5			-5				
	$V_{CB} = -60 V, I_E = 0,$ $T_A = 100^\circ C$			-5				-5		
I_{EBO} Emitter Cutoff Current	$V_{EB} = -5 V, I_C = 0$		-10		-10		-10		-10	μA
hFE Static Forward Current Transfer Ratio	$V_{CE} = -5 V, I_C = -100 \mu A$	30		30		75		75		
	$V_{CE} = -5 V,$ $I_C = -100 mA$	40	120	40	120	100	300	100	300	
	$V_{CE} = -5 V,$ $I_C = -100 mA,$ $T_A = -55^\circ C$	15		15		40		40		
	$V_{CE} = -5 V,$ $I_C = -500 mA$	25		25		70		70		
	$V_{CE} = -5 V,$ $I_C = -1 A$	15		10		40		25		
	$I_B = -15 mA,$ $I_C = -150 mA$		-0.9		-0.9		-0.9		-0.9	
V_{BE} Base-Emitter Voltage	$V_{CE} = -0.5 V,$ $I_C = -500 mA$	See Note 4	-1.1		-1.1		-1.1		-1.1	V
	$V_{CE} = -1 V,$ $I_C = -1 A$		-1.2				-1.2			
	$I_B = -15 mA,$ $I_C = -150 mA$			-0.15		-0.15		-0.15		
$V_{CE(sat)}$ Collector-Emitter Saturation Voltage	$I_B = -50 mA,$ $I_C = -500 mA$	See Note 4		-0.5		-0.5		-0.5		V
	$I_B = -100 mA,$ $I_C = -1 A$			-1				-1		
$ h_{fe} $ Small-Signal Common-Emitter Forward Current Transfer Ratio	$V_{CE} = -10 V, I_C = -50 mA,$ $f = 100 MHz$	1	4	1	4	1.5	5	1.5	5	
C_{cb} Collector-Base Capacitance	$V_{CB} = -10 V, I_E = 0,$ $f = 1 MHz,$ See Note 5	20		20		20		20		pF
C_{ibo} Common-Base Open-Circuit Input Capacitance	$V_{EB} = -0.5 V, I_C = 0,$ $f = 1 MHz$	110		110		110		110		pF

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- NOTES: 4. These parameters must be measured using pulse techniques. $t_w = 300 \mu s$, duty cycle $\leq 2\%$.
 5. C_{cb} measurement employs a three-terminal capacitance bridge incorporating a guard circuit. The emitter is connected to the guard terminal of the bridge.

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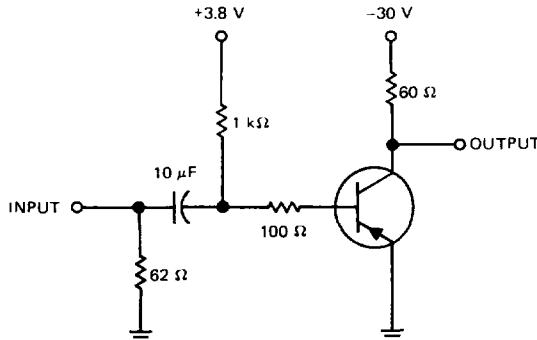
P-N-P SILICON TRANSISTORS

switching characteristics at 25°C free-air temperature

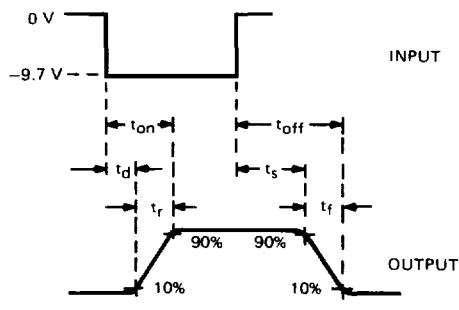
PARAMETER	TEST CONDITIONS [†]	MAX	UNIT
t_{on} Turn-On Time	$V_{CC} = -30$ V, $I_C = -500$ mA,	100	ns
t_s Storage Time	$I_B(1) = -50$ mA, $I_B(2) = 50$ mA,	350	ns
t_f Fall Time	$V_{BE(off)} = 3.8$ V, See Figure 1	50	ns

[†]Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE WAVEFORMS
(See Notes a and b)

- NOTES: a. The input waveform is supplied by a generator with the following characteristics: $Z_{out} = 50 \Omega$, $t_r \leq 20$ ns, $t_f \leq 20$ ns, $t_w \approx 10 \mu s$, duty cycle $\leq 2\%$.
b. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \approx 10$ ns, $R_{in} \geq 100$ kΩ.

FIGURE 1-500-mA SWITCHING TIMES

THERMAL INFORMATION

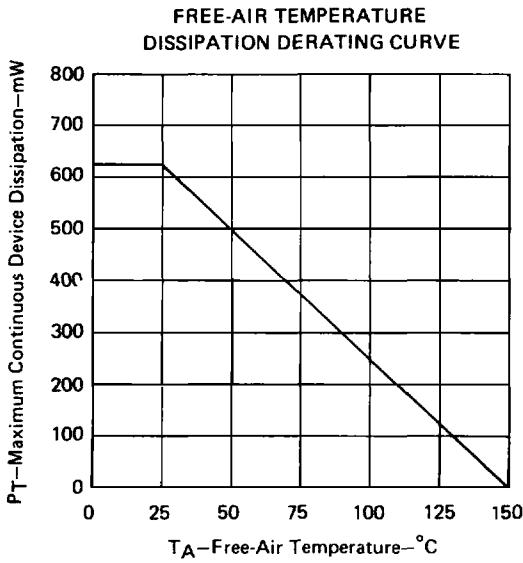


FIGURE 2

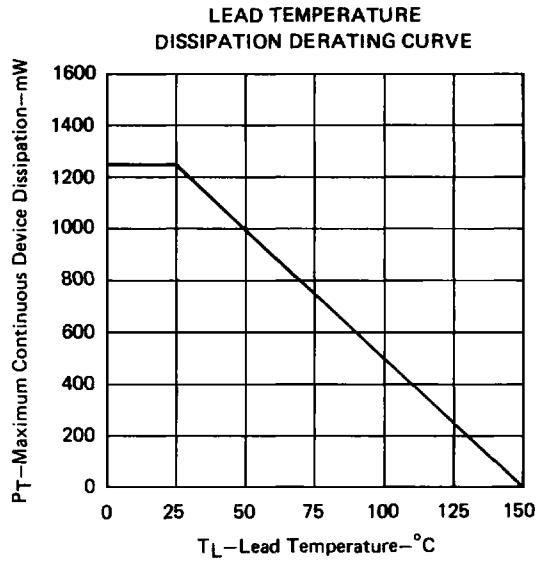


FIGURE 3